

Frequency Timing Generator for Transmeta Systems

Recommended Application:

Transmeta

Output Features:

- 1CPU(2.5V or 3.3V selectable) up to 100MHz.
- 6 PCI (3.3V) @ 33.3MHz (all are free running selectable).
- 1 REF (3.3V) at 14.318MHz.
- 148MHz(3.3V).
- 1 24 48MHz selectable output.

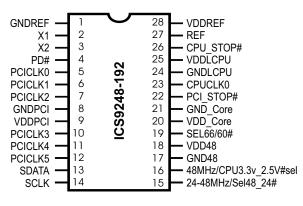
Features:

- Supports Spread Spectrum modulation for CPU and PCI clocks, default ±0.5% center spread.
- Efficient Power management scheme through stop clocks and power down modes.
- Uses external 14.318MHz crystal, no external load cap required for CL=18pF crystal.
- 28-pin TSSOP package, 4.40mm (173mil).

Skew Characteristics:

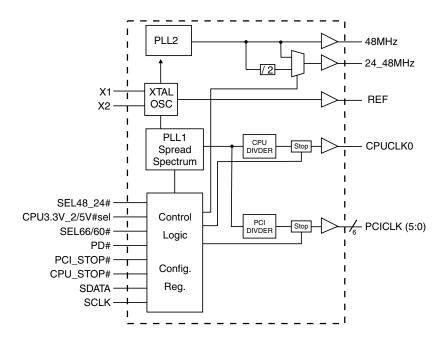
- CPU−CPU≤175ps
- $PCI-PCI \le 500ps$
- CPU(early) PCI = 1.5ns 4ns.

Pin Configuration



28-Pin TSSOP

Block Diagram



Power Groups

VDD Core, GND Core=PLL core VDDREF, GNDREF=REF, X1, X2 VDDPCI, GNDPCI=PCICLK (5:0) VDD48, GND48=48MHz (1:0)

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ICS9248-192

Advance Information



Pin Descriptions

Pin number	Pin name	Type	Description
1	GNDREF	Power	Ground for 14.318 MHz reference clock outputs
2	X1	Input	14.318 MHz crystal input
3	X2	Output	14.318 MHz crystal output
4	PD#	Input	Asynchronous active low input pin used to power down the device into a low power state. The internal clocks are disabled and the VCO and the crystal are stopped. The latency of the power down will not be greater than 3ms.
12, 11, 10, 9, 7, 6, 5	PCICLK (5:0)	Output	3.3V PCI clock outputs, free running selectable
8	GNDPCI	Power	Ground for PCI clock outputs
9	VDDPCI	Power	3.3V power for the PCI clock outputs
15	Sel48_24#	Input	Selects 24MHz or 48MHz output
13	24_48MHz	Output	Selectable output either 24MHz or 48MHz
13	SDATA	I/O	Data pin for I ² C circuitry 5V tolerant
14	SCLK	IN	Clock pin of I ² C circuitry 5V tolerant
16	48MHz	Output	3.3V 48 MHz clock output, fixed frequency clock typically used with USB devices
17	GND48	Power	Ground for 48 MHz clocks
18	VDD48	Power	3.3V power for 48/24 MHz clocks
19	SEL 66/60#	Input	Control for the frequency of clocks at the CPU & PCICLK output pins. "0" = 60 MHz. "1" = 66.6 MHz. The PCI clock is multiplexed to run at 33.3 MHz for both selected cases.
20	VDD_Core	Power	Isolated 3.3V power for core
21	GND_Core	Power	Isolated ground for core
22	PCI_Stop#	Input	Synchronous active low input used to stop the PCICLK in active low state. It will not effect PCICLK_F or any other outputs.
23	CPUCLK0	Output	CPU clock outputs selectable 2.5V or 3.3V.
24	GNDLCPU	Power	Ground for CPU clock outputs
25	VDDLCPU	Power	2.5V or 3.3V power for CPU clock outputs
26	CPU_STOP#	Input	Asynchronous active low input pin used to stop the CPUCLK in active low state, all other clocks will continue to run. The CPUCLK will have a "Turnon" latency of at least 3 CPU clocks.
27	REF	Output	3.3V 14.318 MHz reference clock output
28	VDDREF	Power	3.3V power for 14.318 MHz reference clock outputs.



CPU Select Functions

SEL 66/60#	CPU (MHz)
0	60MHz
1	66.6MHz

Power Management

Clock Enable Configuration

CPU_STOP#	PCI_STOP#	PWR_DWN#	CPUCLK	PCICLK	PCICLK_F	REF	Crystal	VCOs
X	X	0	Low	Low	Low	Stopped	Off	Off
0	0	1	Low	Low	33.3MHz	Running	Running	Running
0	1	1	Low	33.3 MHz	33.3MHz	Running	Running	Running
1	0	1	60/66.6MHz	Low	33.3MHz	Running	Running	Running
1	1	1	60/66.6MHz	33.3 MHz	33.3MHz	Running	Running	Running

Full clock cycle timing is guaranteed at all times after the system has initially powered up except where noted. During power up and power down operations using the PD# pin will not cause clocks of a short or longer pulse than that of the running clock. The first clock pulse coming out of a stopped clock condition may be slightly distorted due to clock network charging circuitry. Board routing and signal loading may have a large impact on the initial clock distortion also.

ICS9248-192 Power Management Requirements

SIGNAL	SIGNAL STATE	Latency No. of rising edges of free running PCICLK
CPU STOP#	0 (Disabled) ²	1
CPU_ 510P#	1 (Enabled) ¹	1
PCI STOP#	0 (Disabled) ²	1
PCI_STOP#	1 (Enabled) ¹	1
PD#	1 (Normal Operation) ³	3ms
FD#	0 (Power Down) ⁴	2max

Notes

- 1. Clock on latency is defined from when the clock enable goes active to when the first valid clock comes out of the device.
- 2. Clock off latency is defined from when the clock enable goes inactive to when the last clock is driven low out of the device.
- 3. Power up latency is when PD# goes inactive (high) to when the first valid clocks are output by the device.
- Power down has controlled clock counts applicable to CPUCLK, PCICLK only.
 The REF will be stopped independant of these.



General I²C serial interface information

The information in this section assumes familiarity with I^2C programming. For more information, contact ICS for an I^2C programming application note.

How to Write:

- Controller (host) sends a start bit.
- Controller (host) sends the write address D2 (H)
- ICS clock will acknowledge
- Controller (host) sends a dummy command code
- ICS clock will acknowledge
- Controller (host) sends a dummy byte count
- ICS clock will acknowledge
- Controller (host) starts sending first byte (Byte 0) through byte 6
- ICS clock will acknowledge each byte one at a time.
- Controller (host) sends a Stop bit

How to Write:					
Controller (Host)	ICS (Slave/Receiver)				
Start Bit					
Address					
D2 _(H)					
	ACK				
Dummy Command Code					
	ACK				
Dummy Byte Count					
	ACK				
Byte 0					
_	ACK				
Byte 1	1011				
5	ACK				
Byte 2	40%				
Ditta 0	ACK				
Byte 3	ACK				
Puto 4	ACK				
Byte 4	ACK				
Byte 5	AUN				
Dyte 3	ACK				
Byte 6	7.51				
2,10 0	ACK				
Stop Bit					

How to Read:

- Controller (host) will send start bit.
- Controller (host) sends the read address D3 (H)
- ICS clock will acknowledge
- ICS clock will send the *byte count*
- Controller (host) acknowledges
- ICS clock sends first byte (Byte 0) through byte 6
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a stop bit

How to Read:					
Controller (Host)	ICS (Slave/Receiver)				
Start Bit					
Address					
D3 _(H)					
	ACK				
	Byte Count				
ACK					
	Byte 0				
ACK					
	Byte 1				
ACK					
	Byte 2				
ACK					
	Byte 3				
ACK					
	Byte 4				
ACK					
	Byte 5				
ACK					
	Byte 6				
ACK					
Stop Bit					

Notes:

- 1. The ICS clock generator is a slave/receiver, I²C component. It can read back the data stored in the latches for verification. **Read-Back will support Intel PIIX4 "Block-Read" protocol**.
- 2. The data transfer rate supported by this clock generator is 100K bits/sec or less (standard mode)
- 3. The input is operating at 3.3V logic levels.
- 4. The data byte format is 8 bit bytes.
- 5. To simplify the clock generator I²C interface, the protocol is set to use only "**Block-Writes**" from the controller. The bytes must be accessed in sequential order from lowest to highest byte with the ability to stop after any complete byte has been transferred. The Command code and Byte count shown above must be sent, but the data is ignored for those two bytes. The data is loaded until a Stop sequence is issued.
- 6. At power-on, all registers are set to a default condition, as shown.



Serial Configuration Command BitmapByte0: Functionality and Frequency Select Register (default = 0)

	Bit2	Bit7	Bit6	Bit5	Bit4	CDII	D.CI	0 10/	DIVID
Bit	FS4	FS3	FS2	FS1	FS0	CPU	PCI	Spread %	PWD
	0	0	0	0	0	60	30	-0.4 % down spread	
	0	0	0	0	1	60	30	-0.6 % down spread	
	0	0	0	1	0	60	30	-0.8 % down spread	
	0	0	0	1	1	60	30	-1.0 % down spread	
	0	0	1	0	0	66.6	33.3	-0.4 % down spread	
	0	0	1	0	1	66.6	33.3	-0.6 % down spread	
	0	0	1	1	0	66.6	33.3	-0.8 % down spread	
	0	0	1	1	1	66.6	33.3	-1.0 % down spread	
	0	1	0	0	0	67.32	33.66	2% over-clocking	
	0	1	0	0	1	68.64	34.32	4% over-clocking	
	0	1	0	1	0	69.96	34.98	6% over-clocking	
	0	1	0	1	1	72.6	36.3	10% over-clocking	
	0	1	1	0	0	61.5	30.75	over-clocking	
	0	1	1	0	1	63	31.5	over-clocking	
	0	1	1	1	0	64	32	over-clocking	
	0	1	1	1	1	65	32.5	over-clocking	00000
Bit	1	0	0	0	0	60	30	+/- 0.5% center spread	00000
2,7:4	1	0	0	0	1	66.6	33.3	+/- 0.5% center spread	
	1	0	0	1	0	50	25	under-clocking	
	1	0	0	1	1	48	24	under-clocking	
	1	0	1	0	0	58.8	29.4	2% under-clock	
	1	0	1	0	1	57.6	28.8	4% under-clock	
	1	0	1	1	0	56.4	28.2	6% under-clock	
	1	0	1	1	1	54	27	10% under-clock	
	1	1	0	0	0	60	30	-1.4 % down spread	
	1	1	0	0	1	60	30	-1.6 % down spread	
	1	1	0	1	0	60	30	-1.8 % down spread	
	1	1	0	1	1	60	30	-2.0 % down spread	
	1	1	1	0	0	66.6	33.3	-1.4 % down spread	
	1	1	1	0	1	66.6	33.3	-1.6 % down spread	
	1	1	1	1	0	66.6	33.3	-1.8 % down spread	
	1	1	1	1	1	66.6	33.3	-2.0 % down spread	
		Hardwa	are latch	inputs	can on	ly access the	ese frequenc	cies	
Bit3						select. Latel	ned input		0
	1-Freq	uency is	selece	d by Bi	t 2, 7:4				U
Bit1	0-Norn				n Enable	d			0
Bit0	0-Runi	ning 1-7	Γristate	all outp	uts				0

Note: PWD=Power-Up Default

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Byte 1: PCI Stop

BIT	PIN#	PWD	DESCRIPTION
Bit 7	12	1	PCICLK5
Bit 6	11	1	PCICLK4
Bit 5	10	1	PCICLK3
Bit 4	7	1	PCICLK2
Bit 3	6	1	PCICLK1
Bit 2	5	1	PCICLK0
Bit 1	-	X	Reserved
Bit 0	-	X	Reserved

Note:

1 = Inactive

0 = Active

Byte 3: Free-Running Enable

BIT	PIN#	PWD	DESCRIPTION
Bit 7	12	1	PCICLK5
Bit 6	11	1	PCICLK4
Bit 5	10	1	PCICLK3
Bit 4	7	1	PCICLK2
Bit 3	6	1	PCICLK1
Bit 2	5	1	PCICLK0
Bit 1	-	X	Reserved
Bit 0	-	X	Reserved

0 = Not free-running (controlled by PCI_STOP# pin) 1 = Free-running (can override Byte1 PCI Stop Control)

Byte 5: Reserved

BIT	PIN#	PWD	DESCRIPTION
Bit 7	-	X	Reserved
Bit 6	-	X	Reserved
Bit 5	-	X	Reserved
Bit 4	-	X	Reserved
Bit 3	-	X	Reserved
Bit 2	-	X	Reserved
Bit 1	-	X	Reserved
Bit 0	-	X	Reserved

Note: PWD = Power-Up Default

Byte 2: Stop Clocks

BIT	PIN#	PWD	DESCRIPTION
Bit 7	16	1	48MHz
Bit 6	15	1	48_24MHz
Bit 5	23	1	CPUCLK0
Bit 4	27	1	REF
Bit 3	-	X	Reserved
Bit 2	-	X	Reserved
Bit 1	-	X	Reserved
Bit 0	-	X	Reserved

Note:

1 = Inactive

0 = Active

Byte 4: Reserved

BIT	PIN#	PWD	DESCRIPTION
Bit 7	-	X	Reserved
Bit 6	ı	X	Reserved
Bit 5	-	X	Reserved
Bit 4	-	X	Reserved
Bit 3	-	X	Reserved
Bit 2	-	X	Reserved
Bit 1	-	X	Reserved
Bit 0	-	X	Reserved

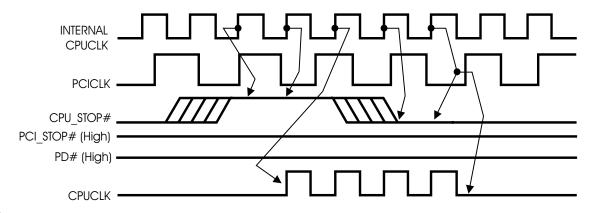
Byte 6: Reserved

BIT	PIN#	PWD	DESCRIPTION
Bit 7	ı	0	Reserved
Bit 6	-	0	Reserved
Bit 5	-	0	Reserved
Bit 4	-	0	Reserved
Bit 3	-	0	Reserved
Bit 2	-	1	Reserved
Bit 1	-	1	Reserved
Bit 0	-	0	Reserved



CPU_STOP#Timing Diagram

CPUSTOP# is an asychronous input to the clock synthesizer. It is used to turn off the CPUCLKs for low power operation. CPU_STOP# is synchronized by the ICS9248-192. The minimum that the CPUCLK is enabled (CPU_STOP# high pulse) is 100 CPUCLKs. All other clocks will continue to run while the CPUCLKs are disabled. The CPUCLKs will always be stopped in a low state and start in such a manner that guarantees the high pulse width is a full pulse. CPUCLK on latency is less than 4 CPUCLKs and CPUCLKs and CPUCLKs.

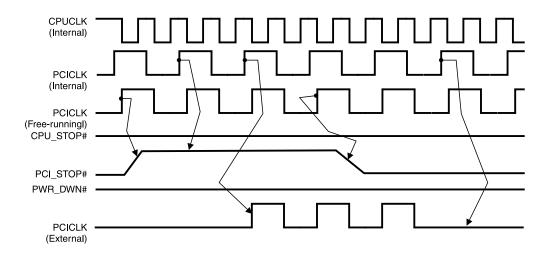


Notes:

- 1. All timing is referenced to the internal CPUCLK.
- CPU_STOP# is an asynchronous input and metastable conditions may exist.
 This signal is synchronized to the CPUCLKs inside the ICS9248-192.
- 3. All other clocks continue to run undisturbed.
- 4. PD# and PCI_STOP# are shown in a high (true) state.

PCI_STOP#Timing Diagram

PCI_STOP# is an asynchronous input to the ICS9248-192. It is used to turn off the PCICLK clocks for low power operation. PCI_STOP# is synchronized by the ICS9248-192 internally. The minimum that the PCICLK clocks are enabled (PCI_STOP# high pulse) is at least 10 PCICLK clocks. PCICLK clocks are stopped in a low state and started with a full high pulse width guaranteed. PCICLK clock on latency cycles are only one rising PCICLK clock off latency is one PCICLK clock.



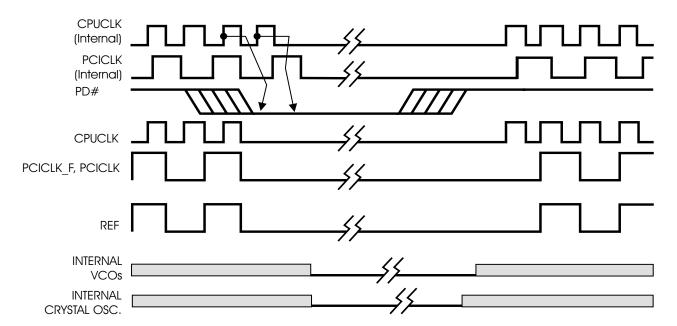
Notes:

- 1. All timing is referenced to the Internal CPUCLK (defined as inside the ICS9248 device.)
- 2. PCI_STOP# is an asynchronous input, and metastable conditions may exist. This signal is required to be synchronized inside the ICS9248.
- 3. All other clocks continue to run undisturbed.
- 4. PD# and CPU STOP# are shown in a high (true) state.



PD#Timing Diagram

The power down selection is used to put the part into a very low power state without turning off the power to the part. PD# is an asynchronous active low input. This signal is synchronized internally by the **ICS9248-192** prior to its control action of powering down the clock synthesizer. Internal clocks will not be running after the device is put in power down state. When PD# is active (low) all clocks are driven to a low state and held prior to turning off the VCOs and the crystal oscillator. The power on latency is guaranteed to be less than 3 ms. The power down latency is less than three CPUCLK cycles. PCI_STOP# and CPU_STOP# are don't care signals during the power down operations.



Notes:

- 1. All timing is referenced to the Internal CPUCLK (defined as inside the ICS9248 device).
- 2. PD# is an asynchronous input and metastable conditions may exist. This signal is synchronized inside the ICS9248.
- 3. The shaded sections on the VCO and the Crystal signals indicate an active clock is being generated.



Absolute Maximum Ratings

Logic Inputs GND –0.5 V to V_{DD} +0.5 V

Ambient Operating Temperature 0°C to +70°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Electrical Characteristics - Input/Supply/Common Output Parameters $T_A = 0$ - 70C; Supply Voltage $V_{DDL} = 2.5 \text{V}$, $V_{DD} = 3.3 \text{ V}$ +/-5% (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input High Voltage	V_{IH}		2		$V_{DD}+0.3$	V
Input Low Voltage	V_{IL}		V_{SS} -0.3	>	0.8	V
Input High Current	I_{IH}	$V_{IN} = V_{DD}$			5	μ^{A}
Input Low Current	I _{IL1}	$V_{IN} = 0$ V; Inputs with no pull-up resistors	> -5			μ^{A}
Input Low Current	I _{IL2}	$V_{IN} = 0$ V; Inputs with pull-up resistors	-200			μ^{A}
Operating	I _{DD2.5OP66}	$C_L = 0 \text{ pF}$; Select @ 66MHz			180	mA
Supply Current	I _{DD2.5OP100}	$C_L = 0 \text{ pF}$; Select @ 100MHz			180	mA
	I _{DD3.3OP66}	$C_L = 0 \text{ pF}$; Select @ 66MHz			180	mA
	I _{DD3.3OP100}	$C_L = 0 \text{ pF}$; Select @ 100MHz			180	mA
Power Down	$I_{\mathrm{DD3.3PD}}$	$C_L = 0$ pF; With input address to Vdd or GND)	\wedge	600	μ^{A}
Supply Current						
Input frequency	Fi	$V_{DD} = 3.3 \text{ V};$	11	14.318	16	MHz
Input Capacitance ¹	C_{IN}	Logic Inputs			5	pF
	C _{INX}	X1 & X2 pins	27	>	45	pF
Transition Time ¹	T _{trans}	To 1st crossing of target Freq.			3	ms
Clk Stabilization ¹	T_{STAB}	From $V_{DD} = 3.3 \text{ V to } 1\% \text{ target Freq.}$			3	ms
Skew ¹	T _{CPU-PCI}	$V_T = 1.5 \text{ V}; V_{TL} = 1.25 \text{ V}$	1.5		4	ns

¹Guaranteed by design, not 100% tested in production.



Electrical Characteristics - CPUCLK

 $T_A = 0 - 70C$; $V_{DD} = 3.3 \text{ V +/-5\%}$, $V_{DDL} = 2.5 \text{ V +/-5\%}$; $C_L = 10 - 20 \text{ pF (unless otherwise stated)}$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output High Voltage	V_{OH2B}	$I_{OH} = -12.0 \text{ mA}$	1.8		\rightarrow	V
Output Low Voltage	V_{OL2B}	$I_{OL} = 12 \text{ mA}$			0.4	V
Output High Current	I_{OH2B}	$V_{OH} = 1.7 \text{ V}$			-27	mA
Output Low Current	I _{OL2B}	$V_{OL} = 0.7 \text{ V}$	27			mA
Rise Time	t_{r2B}^{-1}	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.0 \text{ V}$	0.4		1.6	ns
Fall Time	t _{f2B} ¹	$V_{OH} = 2.0 \text{ V}, V_{OL} = 0.4 \text{ V}$	0.4		1.6	ns
Duty Cycle	d_{t2B}^{1}	$V_T = 1.25 \text{ V}$	44		55	%
Skew	t_{sk2B}^{1}	$V_T = 1.25 \text{ V}$	\nearrow		175	ps
Jitter	t _{jcyc-cyc2B} 1	$V_T = 1.25 \text{ V}$			250	ps
511101	t _{jabs2B} 1	$V_T = 1.25 \text{ V}$	-250		+250	ps

¹Guaranteed by design, not 100% tested in production.

Electrical Characteristics - REF

 $T_A = 0 - 70C$; $V_{DD} = 3.3 \text{ V}$, $V_{DDL} = 2.5 \text{ V}$, +/-5%; $C_L = 10 - 20 \text{ pF}$ (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output High Voltage	V _{OH5}	Iон = -12 mA	2.6			V
Output Low Voltage	V _{OL5}	Iol = 9 mA			0.4	V
Output High Current	Іон5	$V_{OH} = 2.0 \text{ V}$			-22	mA
Output Low Current	Iol5	$V_{OL} = 0.8 \text{ V}$	16			mA
Rise Time ¹	tr5	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.4 \text{ V}$			4	ns
Fall Time ¹	t ₅	$V_{OH} = 2.4 \text{ V}, V_{OL} = 0.4 \text{ V}$			4	ns
Duty Cycle ¹	d _{t5}	$V_T = 1.5 \text{ V}$	45		55	%
1 (t _{jcyc-cyc5}	$V_T = 1.5 \text{ V, REF}$			1000	ps
Jitter 1	tjabs5	$V_T = 1.5 \text{ V, REF}$			800	ps
T' 1	t _{jcyc-cyc5}	$V_T = 1.5 \text{ V}, 48 \text{ MHz}$			500	ps
Jitter ¹	tjabs5	$V_T = 1.5 \text{ V}, 48 \text{ MHz}$			800	ps





Electrical Characteristics - 48MHz

 $T_A = 0$ - 70C; $V_{DD} = 3.3 \text{ V}$, VDDL = 2.5 V, +/-5%; $C_L = 10$ - 20 pF (unless otherwise stated)

		<u> </u>				
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output High Voltage	V _{OH5}	$I_{OH} = -12 \text{ mA}$	2.6		>	V
Output Low Voltage	V _{OL5}	$I_{OL} = 9 \text{ mA}$			0.4	V
Output High Current	Іон5	$V_{OH} = 2.0 \text{ V}$	\ (<		-22	mA
Output Low Current	I _{OL5}	$V_{OL} = 0.8 \text{ V}$	16			mA
Rise Time ¹	t _{r5}	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.4 \text{ V}$			1.2	ns
Fall Time ¹	ts	$V_{OH} = 2.4 \text{ V}, V_{OL} = 0.4 \text{ V}$			1.2	ns
Duty Cycle ¹	dt5	$V_T = 1.5 \text{ V}$	45		55	%
r., 1	t _{jcyc-cyc5}	$V_T = 1.5 \text{ V, REF}$			1000	ps
Jitter ¹	tjabs5	$V_T = 1.5 \text{ V, REF}$			800	ps
Jitter ¹	t _{jcyc-cyc5}	$V_T = 1.5 \text{ V}, 48 \text{ MHz}$			500	ps
	tjabs5	$V_T = 1.5 \text{ V}, 48 \text{ MHz}$			800	ps

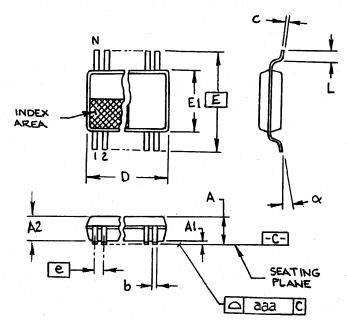
Electrical Characteristics - PCICLK

 $T_A = 0 - 70C$; $V_{DD} = 3.3 \text{ V}$, VDDL = 2.5 V + /-5%; $C_L = 30 \text{ pF}$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output High Voltage	Voн1	$I_{OH} = -18 \text{ mA}$	2.1			V
Output Low Voltage	V _{OL1}	$I_{OL} = 9.4 \text{ mA}$			0.4	V
Output High Current	Іон і	$V_{OH} = 2.0 \text{ V}$			-22	mA
Output Low Current	Tot1	Vol = 0.8 V	16		57	mA
Rise Time ¹	t _{r1}	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.4 \text{ V}$			2	ns
Fall Time ¹	tn	$V_{OH} = 2.4 \text{ V}, V_{OL} = 0.4 \text{ V}$			2	ns
Duty Cycle ¹	d _{t1}	$V_T = 1.5 \text{ V}$	45		55	%
Skew ¹	t _{sk1}	$V_T = 1.5 \text{ V}$			500	ps
Jitter	t _{jcyc-cyc} 1	$V_{T} = 1.5 \text{ V}$			500	ps
Jittei	tjabs1	$V_T = 1.5 \text{ V}$			500	ps

¹Guaranteed by design, not 100% tested in production.





4.40 mm.	Body, 0.65 mm. pitch TSSOP
(173 mil)	(0.0256 Inch)

SYMBOL	In Millin COMMON D	meters IMENSIONS	In Inches COMMON DIMENSIONS		
	MIN	MAX	MIN	MAX	
Α	-	1.20	-	.047	
A1	0.05	0.15	.002	.006	
A2	0.80	1.05	.032	.041	
b	0.19	0.30	.007	.012	
С	0.09	0.20	.0035	.008	
D	SEE VAR	IATIONS	ATIONS SEE VARIATIONS		
Е	6.40 BASIC		0.252	BASIC	
E1	4.30	4.50	.169	.177	
е	0.65	BASIC	0.0256 BASIC		
L	0.45	0.75	.018	.030	
N	SEE VARIATIONS		SEE VARIATIONS		
α	0°	8°	0°	8°	
aaa	-	0.10	-	.004	

VARIATIONS

NI	D m	nm.	D (inch)		
IN	MIN	MAX	MIN	MAX	
28	9.60	9.80	.378	.386	
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Ordering Information

ICS9248<u>y</u>G-192-T

Example:

ICS XXXX y G - PPP - T

Designation for tape and reel packaging

Pattern Number (2 or 3 digit number for parts with ROM code patterns)

Package Type

G=TSSOP

Revision Designator (will not correlate with datasheet revision)

Device Type (consists of 3 or 4 digit numbers)

Prefix

ICS, AV = Standard Device